

Features

- ◆ Ultra low capacitance: 0.3pF typical (I/O to I/O)
- ◆ Ultra low leakage: nA level
- ◆ Low operating voltage: 5V
- ◆ Low clamping voltage
- ◆ Up to 4 data lines and one power line protects
- ◆ Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test
 - Air discharge: $\pm 25\text{kV}$
 - Contact discharge: $\pm 20\text{kV}$
 - IEC61000-4-4 (EFT) 40A (5/50ns)
 - IEC61000-4-5 (Lightning) : 4.7A(8/20 μs)
- ◆ ROHS Compliant

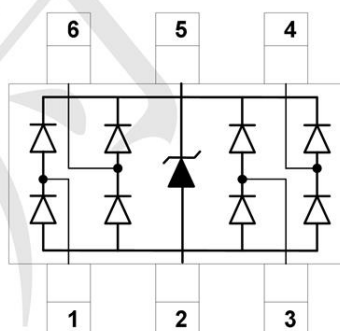
Mechanical Characteristics

- ◆ Package: SOT23-6
- ◆ Lead Finish: Matte Tin
- ◆ Case Material: "Green" Molding Compound.
- ◆ UL Flammability Classification Rating 94V-0
- ◆ Moisture Sensitivity: Level 3 per J-STD-020
- ◆ Shipping Qty :3000/7Inch Tape & Reel

Applications

- ◆ USB 2.0 and USB 3.0 Ports
- ◆ USB OTG
- ◆ Digital video interface(DVI)
- ◆ Monitor and Flat Panel Displays
- ◆ PCI Express and Serial SATA Ports
- ◆ Gigabit Ethernet
- ◆ IEEE 1394 firewire ports
- ◆ Consumer products (STB, DVD, DSC, DVC...)

Dimensions and Pin Configuration



Circuit and Pin Schematic

Marking: C16PJ

Absolute Maximum Ratings (T_{amb}=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (tp=8/20μs) (V _{cc} -GND)	PPP	300	W
Peak Pulse Current (tp=8/20μs)	IPP	4.7	A
ESD per IEC 61000-4-2 (Air)	VESD	±25	kV
ESD per IEC 61000-4-2 (Contact)		±20	
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	Tstg	-55 to +150	°C

Electrical Characteristics (TA=25°C unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			5	V	Any I/O pin to ground
Breakdown Voltage	VBR	6			V	IT = 1mA, any I/O pin to ground
Reverse Leakage Current	IR			0.08	μA	VRWM = 5V, any I/O pin to ground
Clamping Voltage	VC			11	V	IPP = 1A (8 x 20μs pulse) any I/O pin to ground
Clamping Voltage	VC			15	V	IPP = 4.7A (8 x 20μs pulse) any I/O pin to ground
Clamping Voltage	CJ			18	V	IPP = 17A (8 x 20μs pulse) VCC to ground
Junction Capacitance	CJ		0.3	0.4	pF	VR = 0V, f = 1MHz, between I/O pins
Junction Capacitance	CJ			0.8	pF	VR = 0V, f = 1MHz, any I/O pin to ground

Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise Specified)

Fig1. 8/20 μs Pulse Waveform

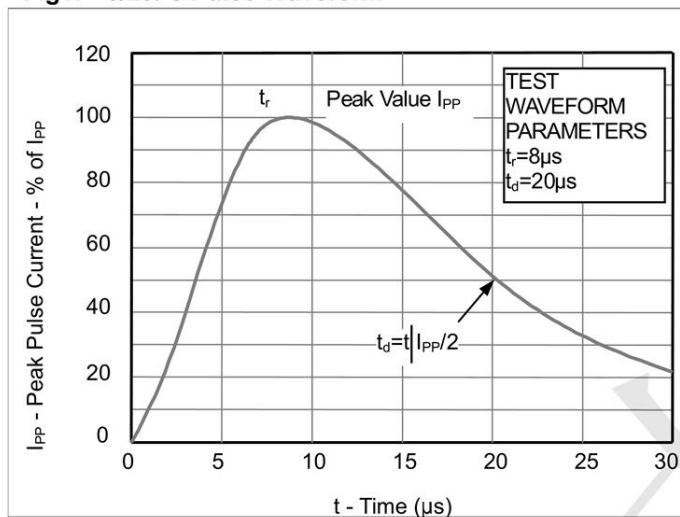


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

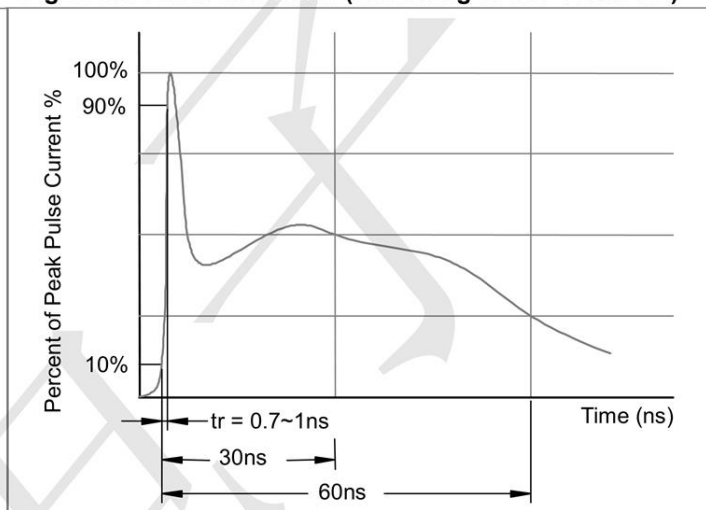
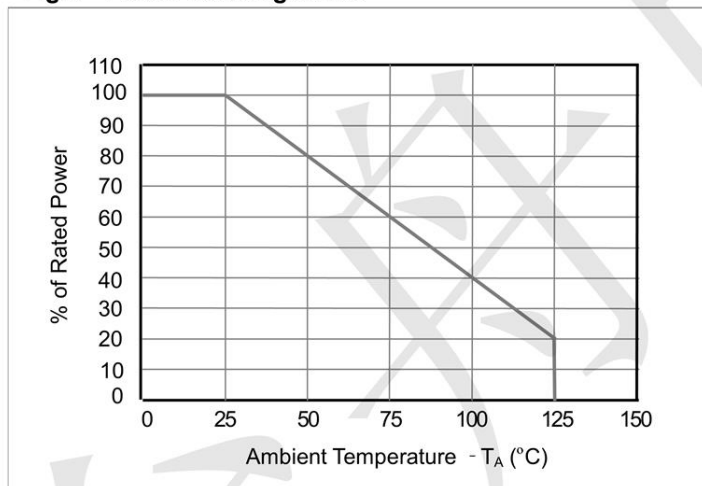
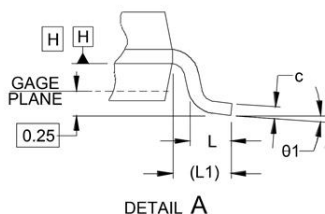
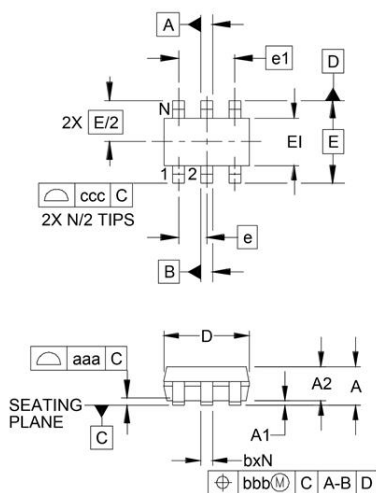


Fig3. Power Derating Curve



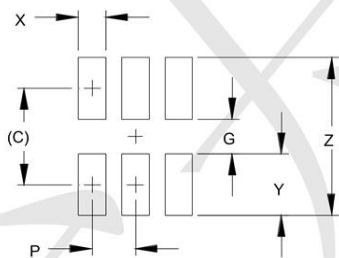
Outline Drawing - SOT23-6



DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.035	-	.057	0.90	-	1.45
A1	.000	-	.006	0.00	-	0.15
A2	.035	.045	.051	.90	1.15	1.30
b	.010	-	.020	0.25	-	0.50
c	.003	-	.009	0.08	-	0.22
D	.110	.114	.118	2.80	2.90	3.00
E1	.060	.063	.069	1.50	1.60	1.75
E	.110 BSC			2.80 BSC		
e	.037 BSC			0.95 BSC		
e1	.075 BSC			1.90 BSC		
L	.012	.018	.024	0.30	0.45	0.60
L1	(.024)			(0.60)		
N	6			6		
01	0°	-	10°	0°	-	10°
aaa	.004			0.10		
bbb	.008			0.20		
ccc	.008			0.20		



Land Pattern - SOT23-6



DIM	INCHES		MILLIMETERS	
C	(.098)		(2.50)	
G	.055		1.40	
P	.037		0.95	
X	.024		0.60	
Y	.043		1.10	
Z	.141		3.60	